Si2367DS

RoHS

COMPLIANT

HALOGEN

FREE

www.vishay.com

Marking code: H7

V_{DS} (V)

Q_q typ. (nC)

Configuration

I_D (A) d

PRODUCT SUMMARY

 $R_{DS(on)}$ max. (Ω) at V_{GS} = -4.5 V

 $R_{DS(on)}$ max. (Ω) at V_{GS} = -2.5 V

 $R_{DS(on)}$ max. (Ω) at V_{GS} = -1.8 V

Vishay Siliconix



-20

0.066

0.086

0.130

9

-3.8

Single

SOT-23 (TO-236)

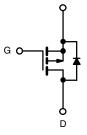
FEATURES

P-Channel 20 V (D-S) MOSFET

- TrenchFET[®] power MOSFET
- 100 % R_g tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- · Load switch for portable devices
- DC/DC converter



P-Channel MOSFET

S

ORDERING INFORMATION	
Package	SOT-23
Lead (Pb)-free and halogen-free	Si2367DS-T1-GE3

ABSOLUTE MAXIMUM RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	-20	v	
Gate-source voltage		V _{GS}	± 8	v	
	T _C = 25 °C		-3.8		
Continuous drain surrent (T 150 °C)	T _C = 70 °C		-3		
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	-2.8 ^{a, b}		
	T _A = 70 °C		-2.2 ^{a, b}	A	
Pulsed drain current (10 µs width)		I _{DM}	-15		
	T _C = 25 °C	۱ _S	-1.4		
Continuous source-drain diode current	T _A = 25 °C		-0.8 ^{a, b}		
Maximum power dissipation	T _C = 25 °C	P _D	1.7		
	T _C = 70 °C		1.1	14/	
	T _A = 25 °C		0.96 ^{a, b}	W	
	T _A = 70 °C	1	0.62 ^{a, b}		
Operating junction and storage temperature rar	nge	T _J , T _{stg}	-55 to +150	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient a, c	t ≤ 5 s	R _{thJA}	100	130	°C/W
Maximum junction-to-foot (drain)	Steady state	R _{thJF}	60	75	0/10

Notes

a. Surface mounted on 1" x 1" FR4 board

b. t = 5 s

c. Maximum under steady state conditions is 175 °C/W

d. T_C = 25 °C

S09-1218-Rev. A, 29-Jun-09

1

Document Number: 65015

Si2367DS

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SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \ \mu A$	-20	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	L _ 250 HA	-	-20	-	mV/°C
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	-	-2.5	-	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	-0.4	-	-1	V
Gate-source leakage	I _{GSS}	V_{DS} = 0 V, V_{GS} = ± 8 V	-	-	± 100	nA
Zero gate voltage drain current	1	$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1	
Zero gate voltage drain current	I _{DSS}	V_{DS} = -20 V, V_{GS} = 0 V, T_{J} = 55 $^{\circ}\text{C}$	-	-	-10	μA
On-state drain current ^a	I _{D(on)}	$V_{DS} \leq$ -5 V, V_{GS} = -4.5 V	-5	-	-	Α
		V_{GS} = -4.5 V, I _D = -2.5 A	-	0.055	0.066	
Drain-source on-state resistance ^a	R _{DS(on)}	V_{GS} = -2.5 V, I_D = -2 A	-	0.071	0.086	Ω
		V_{GS} = -1.8 V, I _D = -1.5 A	-	0.100	0.130	
Forward transconductance a	g _{fs}	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -2.5 \text{ A}$	-	7.5	-	S
Dynamic ^b						
Input capacitance	C _{iss}		-	561	-	pF
Output capacitance	C _{oss}	V_{DS} = -10 V, V_{GS} = 0 V, f = 1 MHz	-	112	-	
Reverse transfer capacitance	C _{rss}		-	89	-	
Tatal asta abaura	0	V _{DS} = -10 V, V _{GS} = -8 V, I _D = -2.5 A	-	15	23	
Total gate charge	Qg		-	9	13.5	
Gate-source charge	Q _{gs}	V_{DS} = -10 V, V_{GS} = -4.5 V, I_{D} = -2.5 A	-	1	-	nC
Gate-drain charge	Q _{gd}		-	2.5	-	
Gate resistance	Rg	f = 1 MHz	2	10	20	Ω
Turn-on delay time	t _{d(on)}		-	20	40	
Rise time	tr	$V_{DD} = -10 \text{ V}, \text{ R}_{L} = 5 \Omega,$	-	20	40	
Turn-off delay time	t _{d(off)}	$I_D \cong$ -2 A, V_{GEN} = -4.5 V, R_g = 1 Ω	-	40	70	
Fall time	t _f		-	10	20	
Turn-on delay time	t _{d(on)}		-	8	16	ns
Rise time	t _r	$V_{DD} = -10 \text{ V}, \text{ R}_{L} = 5 \Omega,$	-	9	18	
Turn-off delay time	t _{d(off)}	$I_D\cong$ -2 A, V_{GEN} = -8 V, R_g = 1 Ω	-	35	65	
Fall time	t _f		-	9	18	
Drain-Source Body Diode Characteris	tics					
Continuous source-drain diode current	Is	T _C = 25 °C	-	-	-1.4	•
Pulse diode forward current	I _{SM}		-	-	-15	A
Body diode voltage	V _{SD}	I _S = -2 A, V _{GS} = 0 V	-	-0.79	-1.2	V
Body diode reverse recovery time	t _{rr}		-	21	35	ns
Body diode reverse recovery charge	Q _{rr}	I _F = -2 A, di/dt = 100 A/μs,	-	15	25	nC
Reverse recovery fall time	ta	$T_J = 25 \text{ °C}$	-	9	-	
•	t _b		_	12	-	ns

Notes

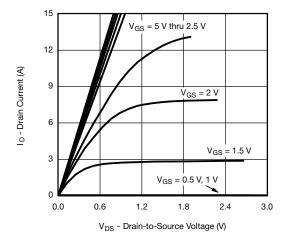
a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

b. Guaranteed by design, not subject to production testing

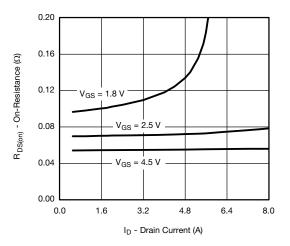
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



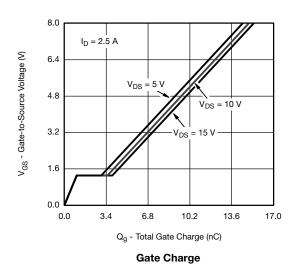
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

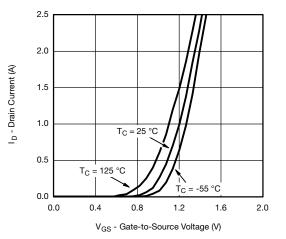


Output Characteristics

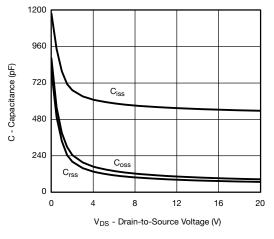


On-Resistance vs. Drain Current and Gate Voltage

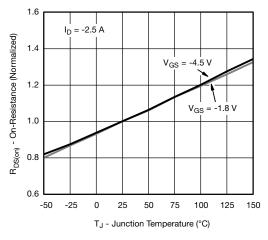




Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

S09-1218-Rev. A, 29-Jun-09

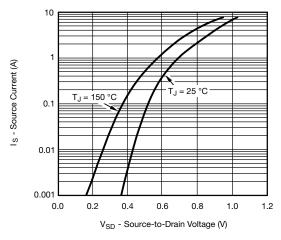
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Document Number: 65015

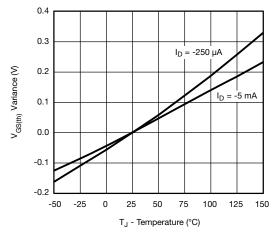
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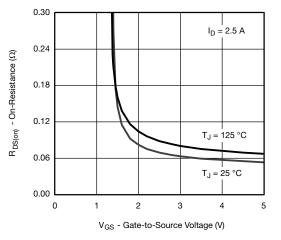
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



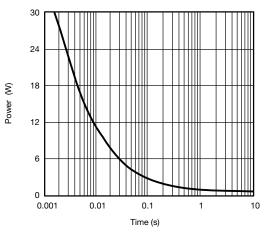
Source-Drain Diode Forward Voltage



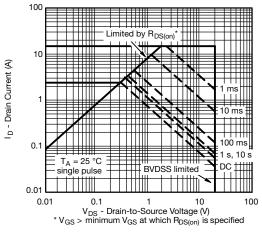




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

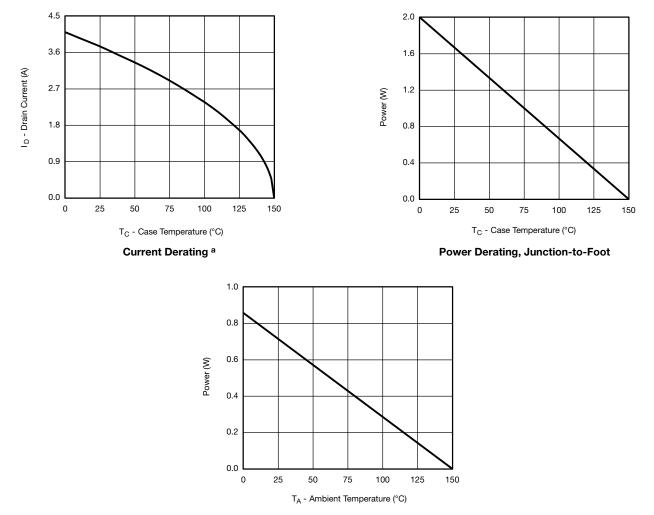


Safe Operating Area, Junction-to-Ambient

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



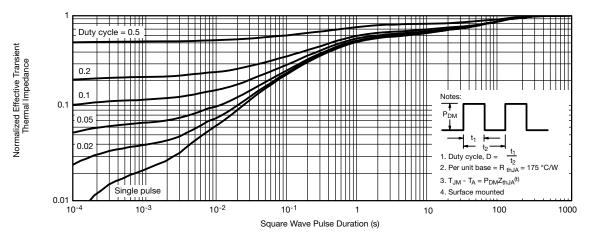
Power, Junction-to-Ambient

Note

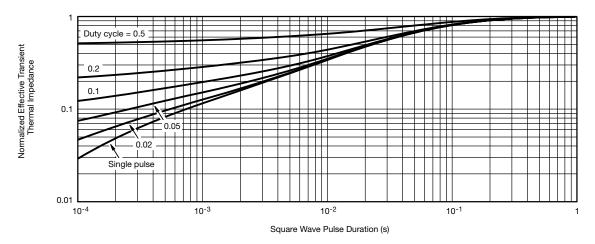
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

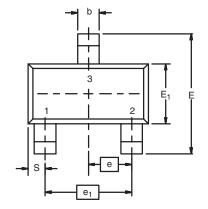
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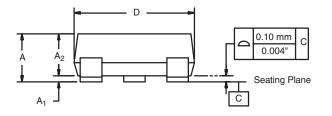


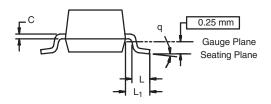
Package Information

Vishay Siliconix

SOT-23 (TO-236): 3-LEAD







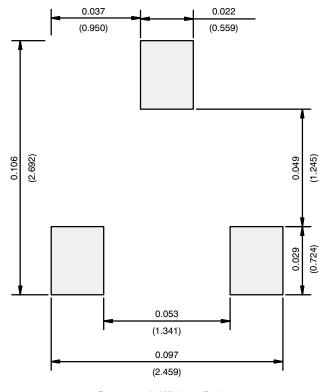
Dim —	MILLIN	IETERS	INCHES		
	Min	Max	Min	Мах	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.02	5 Ref	
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
ECN: S-03946-Rev. K, 09- DWG: 5479	Jul-01				



Application Note 826

Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



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